

**Research Snapshots
from the 40th
Year of the
Semiconductor
Research Corporation**

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TABLE OF CONTENTS

Research Snapshots from the 40th Year of the Semiconductor Research Corporation.....	629
<i>Victor Zhirnov</i>	
Die-Embedded Glass Packaging for 6G Wireless Applications	630
<i>Xiaofan Jia, Xingchen Li, Madhavan Swaminathan</i>	
Structure and Properties of Electrospray Printed Polymeric Films	635
<i>Emma E. Pawliczak, Bryce J. Kingsley, Paul R. Chiarot</i>	
Graphitic Surface Layer Formation on Organic Substrates for Electronics Using a Concentrated Solar Simulator.....	641
<i>Mostafa Abuseada, Abdalla Alghfeli, Timothy S. Fisher</i>	

Author Index